



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





## HiPURformer™ Specifications

Item No.	31331
Accessories	50 g cartridge
Glue	available in 50 gm "no-drip" HiPURformer™ cartridges
Glue Application Temperature	212°F - 284°F (100°C - 140°C)
Open Time	60 sec +/- 15 sec
Warm Up Time	quick 10 - 12 minutes
Max. Application Time	15 - 20 min (cordless gluing)
Final Strength	1 - 5 days (depending on material)
Voltage	120 VAC
Nozzle Diameter	0.9" (22.2 mm)
Net Weight	0.8 lb (12.5 oz)
Dimensions	6.8" x 9.5" x 1.8"
Single Sell Pack	dimensions: 12.0" x 8.0" x 2.9" weight: 1.9 lbs (30.7 oz)
Warranty	one year limited

### HiPURformer™

The HiPURformer™ Advanced Bonding System is the perfect solution for virtually all your bonding needs. It combines the highest quality Polyurethane Reactive (PUR) Hot-Melt adhesives with the most easy to use, cost-effective PUR application system.

All HiPURformer™ adhesives provide strong permanent waterproof bonds, for both interior and exterior use. Quick set times reduce the need for clamping or bracing, and in many applications can eliminate the use of nails or staples. This saves time and money spent on filling, sanding and staining repair marks.

Extremely convenient and easy to use, the HiPURformer™ applicator provides up to 20 minutes of cord-free gluing after a quick 10-12 minute heat up. The charging station includes a green diode to indicate when "ready".

HiPURformer™ adhesives are available in handy 50 gm "no-drip" cartridges.

### Key Features:

- FLX-Valve Technology™ permits easy, controlled extrusion and protection for the adhesive from air and moisture. This ensures initial and repeat use while preventing adhesive drool.
- Durable components provide reliability and long life even under the most rigorous conditions
- Specially designed trigger handle provides refined adhesive control
- 20 minutes of cord-free operation makes it easy to take directly to the project regardless of location
- Indicator lights on the base indicate when the applicator is ready for use
- Quick 10-12 minute heat up



Insert Cartridge



Push Heating Head onto Handle



Heat Up Adhesive



Remove Cap



Indicator Light Indicates Ready for Use



www.steinel.net

### Industry Specific Kits Available



#### HiPURformer™ Kit

- One HiPURformer Adhesive Applicator with Charger
  - One Cartridge WW30
  - One Cartridge WW60
  - One Cartridge MP75
  - Waterproof Carry Case
- No. 31134



### Polyurethane Hot-Melt Adhesives

**Faster** - Shorter set time than “yellow” glues

**Stronger** - More permanent, less brittle bond than “super” glues

**Better** - Outperforms traditional hot-melts: won't foam like other polyurethanes



#### MP75

- Multi-purpose formula with 75 second set time
  - Bonds most common materials including ceramics, metal, most plastics, marble, glass, FRP, brick, wood and more
- No. 31132



#### MP300

- Multi-purpose formula with 5 minute set time
  - Longest set time
  - Ideal for face framing and construction
  - Bonds most common materials including ceramics, metal, most plastics, marble, glass, FRP, brick, wood, and more
- No. 31135



#### WW30

- Wood to wood formula with 30 second set time
  - Designed for quick assembly projects to reduce clamping
- No. 31130



#### WW60

- Wood to wood formula with 60 second set time
  - Higher viscosity fills gaps and irregularities with no shrinkage
- No. 31131

HiPURformer™ adhesives have a shelf life. Always use fresh glue for best performance.

HiPURformer™ polyurethane reactive hot-melt adhesives are manufactured by Franklin International, the makers of Titebond® Glues and Adhesives. For additional information call (800) 347-GLUE or visit [www.titebond.com](http://www.titebond.com).